

Product Name: TPM330FYFG

Package Name: LQFP100

1.Reflow

Number: 2 times maximum

Peak temperature : 260 deg.C maximum instantaneously

Heat : 230 deg.C minimum for 30 to 50 seconds

Pre-heat : 150 to 190 deg.C for 60 to 120 seconds

NOTE: All temperatures refer to the package body surface.

The heat-resistant temperature profile is shown in Fig.1.

The temperatures in this profile are the maximum guaranteed temperatures that the device endures.

Select the temperatures for a pre-heat and a heat most suitable for your solder paste type, etc. within the conditions described in Fig.1.

Since this package is a dry bag product, from opening to the final reflow should take place within 168hr at 30deg.C/70%RH.

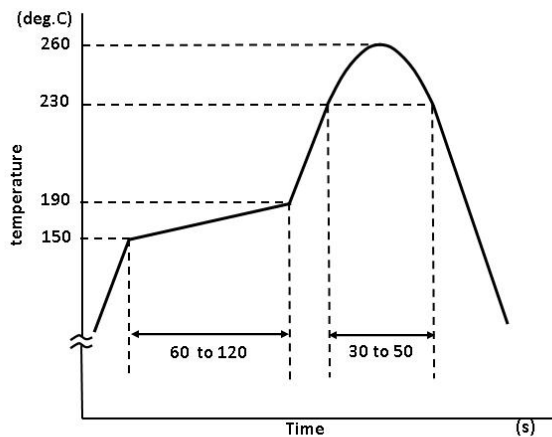


Fig.1 Example of Heat-resistant Temperature Profile

2.Others

We urge you to verify well before mounting to assure enough solder joint strength.

Always solder the Product in accordance with the heat-resistance mounting conditions set forth above. In the event the Product is soldered otherwise, the applicable product warranty, if any, is void.

Moisture Absorption Control Level (Moisture Sensitivity Level)

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Always store the Product under moisture sensitivity level equivalent to level 3 (JEDEC J-STD-020 Moisture Sensitivity Level). In the event the Product is stored otherwise, the applicable warranty, if any, is void.

Always perform reflow soldering in accordance with methods and conditions as specified in applicable engineering documents or specifications provided by Toshiba, or as instructed in writing by your TOSHIBA sales representative.

In the event the Product is soldered otherwise, the applicable product warranty, if any, is void.

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